



TDA18272HN

Hybrid (analog and digital) Silicon Tuner for terrestrial and cable TV reception

Rev. 2 — 11 August 2010

Product data sheet

1. General description

The TDA18272HN is a Silicon Tuner designed for terrestrial and cable TV reception for both analog and digital signals. TDA18272HN/M (Master) is to be used as a stand-alone tuner IC or Master in dual tuner application. TDA18272HN/S (Slave) is only to be used as Slave Silicon Tuner in dual tuner application.

The TDA18272HN supports all analog and digital TV standards and delivers a LOW IF (LIF) signal to a demodulator for analog TV and/or a channel demodulator for digital TV.

2. Features and benefits

- Fully integrated IF selectivity; eliminating the need for external SAW filters
- Worldwide multistandard terrestrial and cable
- Fully integrated oscillators
- Alignment free
- Single 3.3 V supply voltage
- Integrated wideband gain control
- Crystal oscillator output buffer (16 MHz) for single crystal applications
- I²C-bus interface compatible with 3.3 V microcontrollers
- Slave tuner output function to drive second (slave) Silicon Tuner
- Easy programming
- 5 ms tuning time
- LIF channel center frequency output ranging from 3 MHz to 5 MHz
- 1.7 MHz, 6 MHz, 7 MHz, 8 MHz and 10 MHz channel bandwidths
- Ready for DVB-T2
- RoHS compliant

3. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f _{RF}	RF frequency	full range of RF input	42	-	870	MHz
NF _{tun}	tuner noise figure	75 Ω source; maximum gain	-	5.0	-	dB



Table 1. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
ϕ_{jit}	phase jitter	UHF; integrated from 250 Hz to 4 MHz	-	0.4	0.6	degree
α_{image}	image rejection	worst case for image rejection and 4 MHz IF frequency for levels above -50 dBm	57.5	63	-	dB
ICP _{1dB}	1 dB input compression point	at tuner input and minimum gain	124	-	-	dB μ V

4. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
TDA18272HN/M/C1 ^[1]	HVQFN40	plastic thermal enhanced very thin quad flat package; no leads; 40 terminals; body 6 × 6 × 0.85 mm	SOT618-1
TDA18272HN/S/C1 ^[2]			

[1] M for master.

[2] S for slave.

5. Block diagram

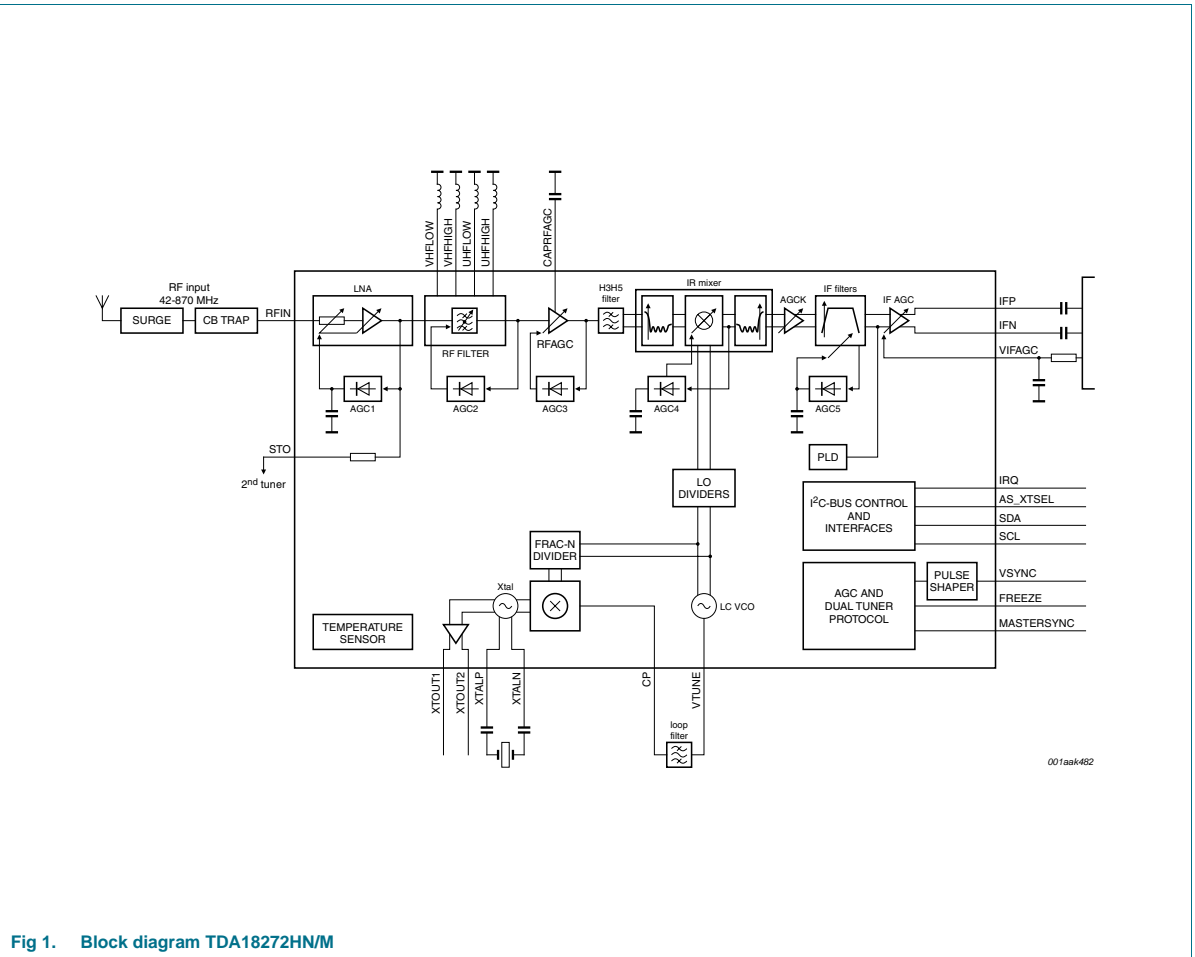


Fig 1. Block diagram TDA18272HN/M

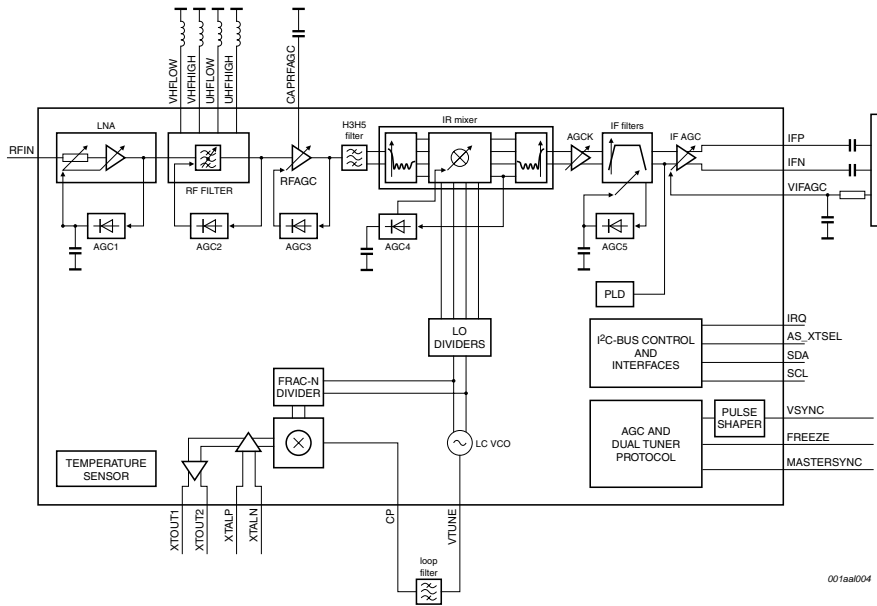


Fig 2. Block diagram TDA18272HN/S

6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.3	+3.6	V
V_I	input voltage	pins SDA and SCL	-0.3	+3.6	V
		all other pins:			
		$V_{CC} < 3.3$ V	-0.3	$V_{CC} + 0.3$	V
		$V_{CC} > 3.3$ V	-0.3	+3.6	V
T_{stg}	storage temperature		-40	+150	°C
T_j	junction temperature		-	125	°C
T_{amb}	ambient temperature		-20	[1]	°C
V_{ESD}	electrostatic discharge voltage	EIA/JESD22-A114 (human body model)	-2	+2	kV
		EIA/JESD22-C101-C (FCDM) class III[2]	750	-	V

[1] The maximum allowed ambient temperature $T_{amb(max)}$ depends on the assembly conditions of the package and especially on the design of the Printed-Circuit Board (PCB) and die connection. The application mounting must be done in such a way that the maximum junction temperature is never exceeded. The junction temperature can be obtained by reading the temperature sensor bit via I²C-bus. The junction temperature: $T_j = T_{amb} + \Delta T_{j-c}$, where $\Delta T_{j-c} = power \times R_{th}$.

[2] Class III: 500 V to 1000 V.

7. Abbreviations

Table 4. Abbreviations

Acronym	Description
AGC	Automatic Gain Control
AGCK	Automatic Gain Control number K
CB	Citizens' Band
DVB	Digital Video Broadcasting
DVB-T/T2/C/H	DVB-Terrestrial/Terrestrial second generation/Cable/Handheld
ESD	ElectroStatic Discharge
FCDM	Field-Induced Charged-Device Model
FRAC-N	FRACTIONal-N
IC	Integrated Circuit
IF	Intermediate Frequency
IRQ	Interrupt ReQuest
LC-VCO	Inductors and Capacitors - Voltage Controlled Oscillator
LNA	Low-Noise Amplifier
LO	Local Oscillator
PCB	Printed Circuit Board
RF	Radio Frequency
RoHS	Restriction on Hazardous Substances
SAW	Surface Acoustic Wave

Table 4. Abbreviations ...continued

Acronym	Description
STO	Slave Tuner Output
UHF	Ultra High Frequency
VCO	Voltage Controlled Oscillator

8. Revision history

Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TDA18272HN_SDS v.2 ^[1]	20100811	Product data sheet	-	-

[1] Revision 1 is not available

9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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11. Tables

Table 1. Quick reference data1
Table 2. Ordering information2
Table 3. Limiting values5
Table 4. Abbreviations 5
Table 5. Revision history 6

12. Figures

Fig 1. Block diagram TDA18272HN/M.....3
Fig 2. Block diagram TDA18272HN/S.....4

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13. Contents

1	General description	1
2	Features and benefits	1
3	Quick reference data	1
4	Ordering information	2
5	Block diagram	3
6	Limiting values	5
7	Abbreviations	5
8	Revision history	6
9	Legal information	7
9.1	Data sheet status	7
9.2	Definitions	7
9.3	Disclaimers	7
9.4	Licenses	8
9.5	Trademarks	8
10	Contact information	8
11	Tables	9
12	Figures	9
13	Contents	10

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